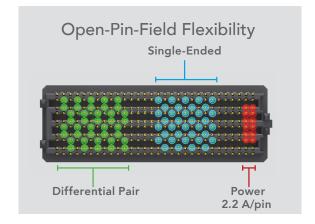


LOW PROFILE OPEN-PIN-FIELD ARRAYS

LP ARRAY™ HIGH-SPEED/HIGH-DENSITY SYSTEMS

Up to 400 total pins

- Low profile stack heights: 4 mm, 4.5 mm and 5 mm
- .050" (1.27 mm) pitch for maximum grounding and routing flexibility
- Up to 50 pins per row
- 4, 6 or 8 row configurations
- Dual beam contact system
- Solder crimped termination for ease of processing
- Press-in or threaded standoffs available to assist with unmating (JSO)







Dual beam contacts

Low profile design

Press-in or threaded stand offs

LP Array™ is compatible with mPOWER® for flexible two-piece power/signal solutions.



System

- LPAM .050" (1.27 mm) Pitch Array Terminal
- LPAF .050" (1.27 mm) Pitch Array Socket
- JSO Jack Screw Precision Board Stacking Standoff